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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/654,412	09/01/2000	Tatsuya Nakagawa	PM 273795	15709

909            7590            07/31/2002

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EXAMINER

PHAN, THANH S

ART UNIT            PAPER NUMBER

2841

DATE MAILED: 07/31/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

<b>Office Action Summary</b>	Application No.	Applicant(s)
	09/654,412	NAKAGAWA, TATSUYA
Examiner	Art Unit	
Thanh S Phan	2841	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --  
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) Responsive to communication(s) filed on \_\_\_\_.  
 2a) This action is FINAL.                  2b) This action is non-final.  
 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) Claim(s) 1-4 and 7-13 is/are pending in the application.  
 4a) Of the above claim(s) \_\_\_\_ is/are withdrawn from consideration.  
 5) Claim(s) \_\_\_\_ is/are allowed.  
 6) Claim(s) 1-4 and 7-13 is/are rejected.  
 7) Claim(s) \_\_\_\_ is/are objected to.  
 8) Claim(s) \_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) The specification is objected to by the Examiner.  
 10) The drawing(s) filed on \_\_\_\_ is/are: a) accepted or b) objected to by the Examiner.  
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
 11) The proposed drawing correction filed on \_\_\_\_ is: a) approved b) disapproved by the Examiner.  
 If approved, corrected drawings are required in reply to this Office action.  
 12) The oath or declaration is objected to by the Examiner.

**Priority under 35 U.S.C. §§ 119 and 120**

- 13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).  
 a) All b) Some \* c) None of:  
 1. Certified copies of the priority documents have been received.  
 2. Certified copies of the priority documents have been received in Application No. \_\_\_\_.  
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).  
 \* See the attached detailed Office action for a list of the certified copies not received.  
 14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  
 a) The translation of the foreign language provisional application has been received.  
 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

**Attachment(s)**

- |   |   |
|---|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892)                   | 4) <input type="checkbox"/> Interview Summary (PTO-413) Paper No(s). ____ . |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)          | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449) Paper No(s) ____ . | 6) <input type="checkbox"/> Other: _____                                    |

## DETAILED ACTION

### ***Claim Rejections - 35 USC § 103***

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claim 1 is rejected under 35 U.S.C. 103(a) as being unpatentable over Fukui et al. (U. S Pat # 3,978,375) in view of Coucoulas (U.S Pat # 3,959,874).

Regarding claim 1. Fukui et al. discloses a component mounting circuit board comprising: a circuit pattern including a plurality of electrically conductive plate (reference 1); and a resin molded section made of a resin by way of molding so as to cover the circuit pattern and the inner electrical component (reference 6), the resin molded section having an opening (reference 3) allowing an outer electrical component (reference 4) located outside the resin molded section to be connected to the circuit pattern therethrough. However, Fukui et al. does not discloses an inner electrical component electrically connected to the circuit pattern. Coucoulas discloses an inner electronical component (11). It would have been obvious to one of ordinary skill in the art to modify Fukui et al.'s circuit with Coucoulas' teaching for the purpose of providing additional capacities.

Regarding claim 2. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1, and Fukui et al. further discloses wherein the resin molded section is made of an epoxy resin (column 3, lines 4-6).

Regarding claim 3. Fukui et al. and Coucoulas discloses the component mounting circuit board according to 1, and Fukui et al. further disclose wherein a portion of the circuit pattern corresponding to the inner electrical component has member coupled thereto, the member and the portion being thicker than a remaining portion (figure 17).

Regarding claim 4. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1, and further discloses wherein the circuit pattern corresponding to the inner electrical component and has an exposed portion exposed outside the resin molded section (figure 16).

Regarding claim 7. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1, further comprising a support (references 18, 19, 20) provided on the resin molded section to support the outer electrical component.

Regarding claim 8. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1 except for further comprising a terminal provided on the circuit pattern so as to project outside the resin molded section. It would have been obvious to one of ordinary skill in the art at the time of the invention was made to have the circuit pattern extended outside of the resin molded section since it was known in the art that such extension would provide electrical connection with addition devices.

Regarding claim 9. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1 except for the inner electrical component is connected to the

circuit pattern by wire bonding. It would have been obvious in the art to use wire bonding to provide connection.

Regarding claim 10. Fukui et al. and Coucoulas disclose the component mounting circuit board according to claim 1. Fukui et al. further discloses wherein the outer electrical component is soldered to a portion of the circuit pattern corresponding to the opening (Figure 13a).

Claims 11-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fukui et al. and Gold et al. as applied to the claims above, and further in view of Takeuji et al. (U.S Pat # 4,812,617).

Regarding claim 11. Fukui et al. and Gold et al. disclose a component mounting circuit board comprising: a circuit pattern including a plurality of electrically conductive plates; an inner electrical component electrically connected to the circuit pattern; and a resin molded section made of a resin by way of molding so as to cover the circuit pattern and the inner electrical component. However do not disclose the component mounting circuit board is incorporated in a microwave oven and on which a power supply circuit for driving a magnetron, a switching circuit, etc. are mounted. Takeuji et al. discloses a microwave oven comprising a printed circuit board supporting a plurality of circuit elements (Abstract lines 7-9). It would have been obvious to one of ordinary skill in the art at the time of the invention was made to use the combination of Fukui et al. and Gold et al.'s circuit board in Takeuji et al.'s microwave oven for the purpose of minimizing space usage and better heat diffusion.

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Regarding claim 12. The component mounting circuit board according to claim 11, wherein the resin molded section includes an opening used when an outer electrical component located outside the resin molded section is connected to the circuit pattern (see claim 1).

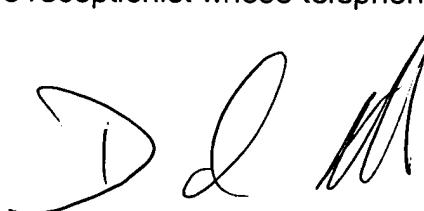
Regarding claim 13. The method steps are inherent since the limitations of the apparatus are disclosed.

#### **Contact Information**

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanh S Phan whose telephone number is 703-305-0069. The examiner can normally be reached on M-F 9:00-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David S Martin can be reached on 703-308-3121. The fax phone numbers for the organization where this application or proceeding is assigned are 703-305-7722 for regular communications and 703-305-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.



TSP  
July 29, 2002

**DAVID MARTIN**  
**SUPERVISORY PATENT EXAMINER**  
**TECHNOLOGY CENTER 2800**